Unit: mm

TOSHIBA Transistor Silicon NPN Epitaxial Planar Type

# 2SC5087

#### VHF~UHF Band Low Noise Amplifier Applications

• Low noise figure, high gain.

• NF = 1.1dB,  $|S_{21e}|^2 = 13dB$  (f = 1 GHz)

#### **Absolute Maximum Ratings (Ta = 25°C)**

Characteristics	Symbol	Rating	Unit	
Collector-base voltage	$V_{CBO}$	20	V	
Collector-emitter voltage	V <sub>CEO</sub>	12	V	
Emitter-base voltage	V <sub>EBO</sub>	3	V	
Base current	ΙΒ	40	mA	
Collector current	IC	80	mA	
Collector power dissipation	PC	150	mW	
Junction temperature	Tj	125	°C	
Storage temperature range	T <sub>stg</sub>	-55 to 125	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

+0.2 2.9-0.3 4 90 0.85 +0.25 1.50-0.15 5° \$000-1:1

1, 3. EMITTER 2. BASE

4. COLLECTOR

JEDEC —
JEITA —
TOSHIBA 2-3J1C

Weight: 0.012 g (typ.)

2.9 ± 0.2

### Microwave Characteristics (Ta = 25°C)

Characteristics	Symbol Test Condition		Min	Тур.	Max	Unit
Transition frequency	f <sub>T</sub>	V <sub>CE</sub> = 10 V, I <sub>C</sub> = 20 mA	5	7	_	GHz
Insertion gain	$ S_{21e} ^2$ (1)	$V_{CE} = 10 \text{ V}, I_{C} = 20 \text{ mA}, f = 500 \text{ MHz}$		18		dB
	S <sub>21e</sub>   <sup>2</sup> (2)	V <sub>CE</sub> = 10 V, I <sub>C</sub> = 20 mA, f = 1 GHz	9.5	13	_	ub
Noise figure	NF (1)	V <sub>CE</sub> = 10 V, I <sub>C</sub> = 5 mA, f = 500 MHz	_	1	_	dB
	NF (2)	$V_{CE} = 10 \text{ V}, I_{C} = 5 \text{ mA}, f = 1 \text{ GHz}$		1.1	2	T UB

#### **Electrical Characteristics (Ta = 25°C)**

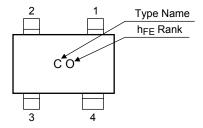
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = 10 V, I <sub>E</sub> = 0	_	_	1	μА
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = 1 V, I <sub>C</sub> = 0	_	_	1	μΑ
DC current gain	h <sub>FE</sub> (Note 1)	V <sub>CE</sub> = 10 V, I <sub>C</sub> = 20 mA	80	_	240	
Output capacitance	C <sub>ob</sub>	V <sub>CB</sub> = 10 V, I <sub>E</sub> = 0, f = 1 MHz (Note 2)	_	1.1	1.6	pF
Reverse transfer capacitance	C <sub>re</sub>	VCB = 10  V, IE = 0, I = 1  MHZ (Note 2)	_	0.65	1.05	pF

Note 1: hFE classification O: 80 to 160, Y: 120 to 240

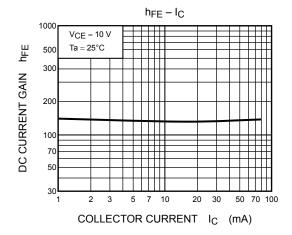
Note 2: C<sub>re</sub> is measured by 3 terminal method with capacitance bridge.

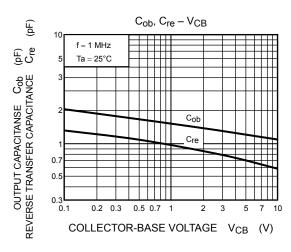
Start of commercial production 1993-10

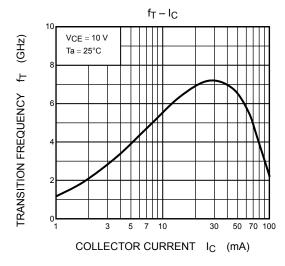
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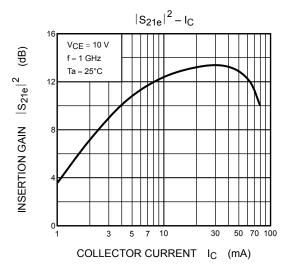


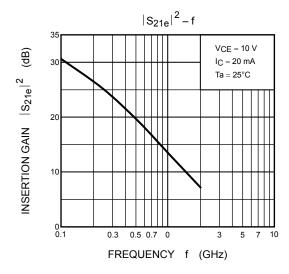
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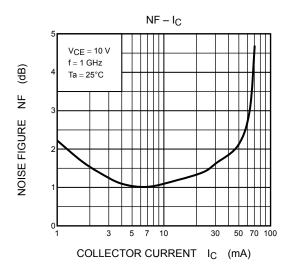




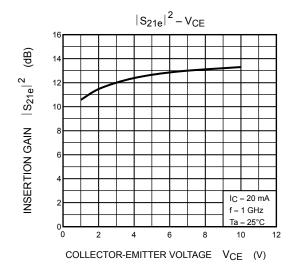


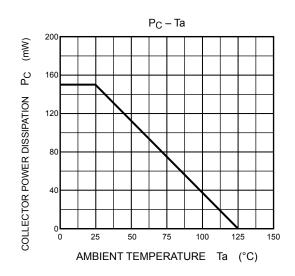






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### S-Parameter $Z_O = 50 \Omega$ , $Ta = 25^{\circ}C$

 $V_{CE} = 10 \text{ V}, I_C = 5 \text{ mA}$ 

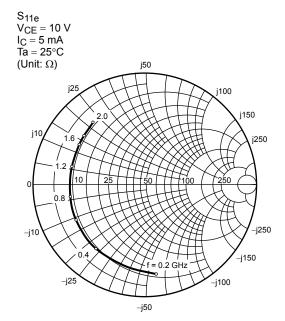
Frequency	S	11	S21		S12		S22	
MHz	Mag.	Ang.	Mag.	Ang.	Mag.	Ang.	Mag.	Ang.
200	0.793	-82.4	11.923	133.4	0.050	52.7	0.788	-36.4
400	0.736	-128.0	7.835	108.5	0.066	38.0	0.584	-53.4
600	0.719	-152.1	5.578	94.5	0.071	34.1	0.490	-63.5
800	0.701	-168.6	4.279	84.4	0.073	33.9	0.445	-72.2
1000	0.698	178.9	3.451	76.6	0.074	36.7	0.424	-80.5
1200	0.697	168.3	2.855	69.9	0.076	40.8	0.413	-88.9
1400	0.699	159.4	2.440	64.0	0.078	46.6	0.404	-97.3
1600	0.703	150.8	2.121	59.3	0.084	52.5	0.401	-105.4
1800	0.713	142.9	1.876	54.5	0.091	58.3	0.398	-112.6
2000	0.722	134.7	1.681	50.3	0.100	63.5	0.398	-119.6

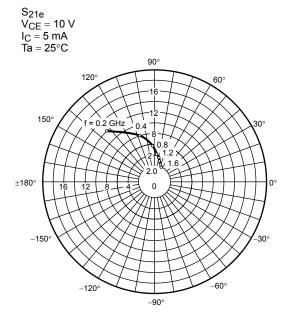
 $V_{CE} = 10 \text{ V}, I_C = 20 \text{ mA}$ 

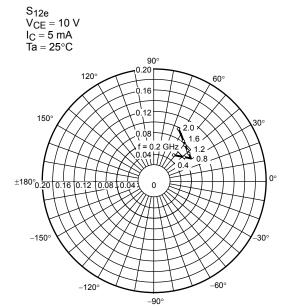
Frequency	S11		S21		S12		S22	
MHz	Mag.	Ang.	Mag.	Ang.	Mag.	Ang.	Mag.	Ang.
200	0.655	-129.4	20.724	113.2	0.031	48.0	0.496	-59.6
400	0.650	-161.5	11.288	95.5	0.040	50.4	0.319	-74.1
600	0.660	-176.3	7.643	86.4	0.049	56.4	0.263	-83.5
800	0.666	172.8	5.758	79.6	0.059	60.0	0.242	-92.9
1000	0.667	164.0	4.605	74.2	0.070	63.6	0.233	-102.0
1200	0.668	156.8	3.809	69.3	0.080	65.9	0.229	-111.0
1400	0.677	148.4	3.277	65.1	0.091	68.2	0.226	-119.1
1600	0.676	141.1	2.862	61.2	0.104	70.0	0.223	-126.5
1800	0.688	133.9	2.559	57.5	0.117	71.2	0.220	-132.4
2000	0.690	126.7	2.303	54.1	0.131	72.4	0.217	-137.8

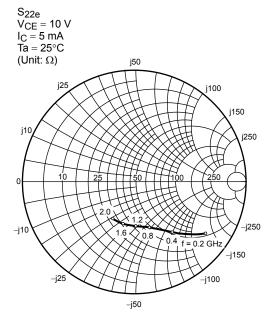
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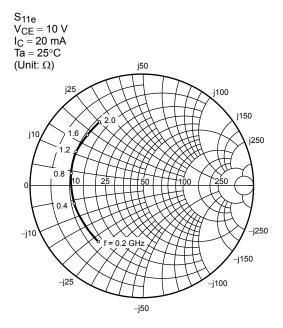
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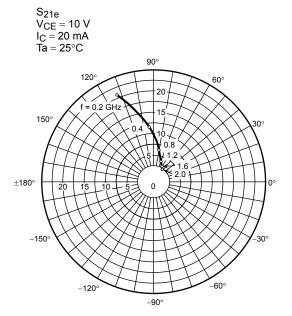




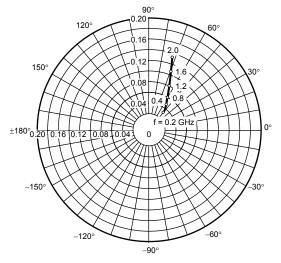


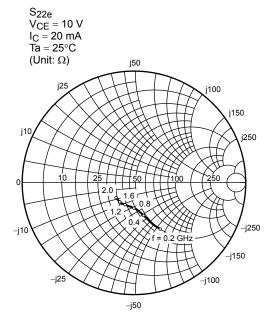












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